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## BGO827; BGO827/FC0; BGO827/SC0

870 MHz optical receivers

Rev. 5 — 29 September 2010

**Product data sheet** 

## 1. Product profile

### 1.1 General description

High dynamic range optical receiver amplifier modules in a standard SOT115 package where the non-jacketed fiber has either no connector or has an FC/APC or SC/APC connector.

The amplifier supply voltage pin and the photodiode bias voltage pin both connect to 24 V (DC).

The modules have a mono mode optical input suitable for 1290 nm to 1600 nm wavelengths, a terminal to monitor the photodiode current and an electrical output having a characteristic impedance of 75  $\Omega$ .

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### **1.2 Features and benefits**

- Excellent linearity
- Low noise
- Excellent flatness
- Standard CATV outline
- Rugged construction
- Gold metallization ensures excellent reliability
- High optical input power range

### **1.3 Applications**

• CATV optical node systems operating in the 40 MHz to 870 MHz frequency range.



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### 1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f	frequency range		40	-	870	MHz
S <sub>22</sub>	output return losses	f = 40  MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB
d <sub>2</sub>	second order distortion	f = 854.5 MHz	-	-	-57	dB
F	equivalent noise input	f = 40  MHz to 870 MHz	-	-	8.5	pA/√Hz
I <sub>tot</sub>	total current consumption (DC)	V <sub>B</sub> = 24 V	175	-	205	mA

## 2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
BGO827	(SOT115T)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		╼╡╪┻╵
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BG0827/	FC0 (SOT115X)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		✐╡╪┻╵
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BG0827/	SC0 (SOT115Y)		
1	monitor current		_
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		╼╡╪┻╵
7, 8	common		1 2, 3, 7, 8
9	output		sym098

## 3. Ordering information

Type number	Package							
	Name	Description	Version					
BGO827	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads	SOT115T					
BGO827/FC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115X					
BGO827/SC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115Y					

## 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
f	frequency range		40	870	MHz
T <sub>stg</sub>	storage temperature		-40	+85	°C
T <sub>mb</sub>	mounting base temperature		-20	+85	°C
P <sub>in</sub>	optical input power	continuous	-	5	mW
ESD	ESD sensitivity	human body model; R = 1.5 k $\Omega$ ; C = 100 pF	500	-	V

## 5. Characteristics

#### Table 5. Characteristics

Bandwidth 40 MHz to 870 MHz;  $V_B = 24 V$ ;  $T_{mb} = 30 \circ C$ ;  $Z_L = 75 \Omega$ .

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
S	responsivity					
	BGO827	$\lambda = 1300 \text{ nm}$	800	-	-	V/W
	BGO827/FC0; BGO827/SC0		750	-	-	V/W
ΔS	responsivity difference	responsivity at T <sub>mb</sub> = 85 °C – responsivity at T <sub>mb</sub> = 30 °C; f = 870 MHz	-	-50	-	V/W
FL	flatness straight line (peak to valley)	f = 40 MHz to 870 MHz	-	-	1	dB
SL	slope straight line	f = 40 MHz to 870 MHz	0	-	2	dB
∆SL	slope difference	slope at $T_{mb}$ = 85 °C – slope at $T_{mb}$ = 30 °C	-	-0.35	-	dB
\$ <sub>22</sub>	output return losses	f = 40 MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB

870 MHz optical receivers

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
d <sub>2</sub>	second order distortion	f <sub>m</sub> = 446.5 MHz	[1][2]	-	-	-68	dB
		f <sub>m</sub> = 746.5 MHz	<u>[1][3]</u>	-	-	-63	dB
		f <sub>m</sub> = 854.5 MHz	<u>[1][4]</u>	-	-	-57	dB
∆d2	second order distortion difference	$d_2$ at $T_{mb}$ = 85 °C – $d_2$ at $T_{mb}$ = 30 °C		-	2.5	-	dB
		$d_2$ at $T_{mb} = -20 \text{ °C} - d_2$ at $T_{mb} = 30 \text{ °C}$		-	-1.5	-	dB
d <sub>3</sub>	third order distortion	f <sub>m</sub> = 853.25 MHz	[5][6]	-	-	-73	dB
$\Delta d3$	third order distortion difference	$d_3$ at $T_{mb}$ = 85 °C – $d_3$ at $T_{mb}$ = 30 °C		-	1	-	dB
		$d_3$ at $T_{mb} = -20 \text{ °C} - d_3$ at $T_{mb} = 30 \text{ °C}$		-	-1	-	dB
F	equivalent noise input	f = 40 MHz to 450 MHz		-	-	7	pA/√H
		f = 450 MHz to 750 MHz		-	-	8	pA/√H
		f = 750 MHz to 870 MHz		-	-	8.5	pA/√H
s <sub>λ</sub>	spectral sensitivity	$\lambda$ = 1310 ±20 nm		0.85	-	-	A/W
		$\lambda = 1550 \pm 20 \text{ nm}$		0.9	-	-	A/W
λ	optical wavelength			1290	-	1600	nm
L	length of optical fiber	SM type; 9/125 μm					
	BGO827			1	-	-	m
	BGO827/FC0; BGO827/SC0			746	-	861	mm
I <sub>tot</sub>	total current consumption (DC)			175	-	205	mA
I <sub>bias</sub>	diode bias current at pin 4 (DC)			-	-	25	mA

#### Table 5. Characteristics ... continued

[1] Two laser test; each laser with a modulation index of 40 %; P<sub>opt</sub> = 1 mW (total)

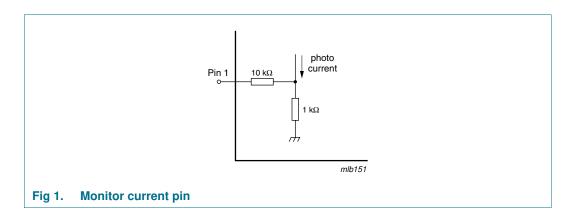
[2]  $f_m = 446.5 \text{ MHz}; f_p = 97.25 \text{ MHz}; f_q = 349.25 \text{ MHz}$ 

 $[3] \quad f_m = 746.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 613.25 \text{ MHz}$ 

[4]  $f_m = 854.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 721.25 \text{ MHz}$ 

[5] Three laser test; each laser with a modulation index of 60 %;  $P_{opt} = 1 \text{ mW}$  (total)

[6]  $f_m = 853.25 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 265.25 \text{ MHz}; f_r = 721.25 \text{ MHz}$ 

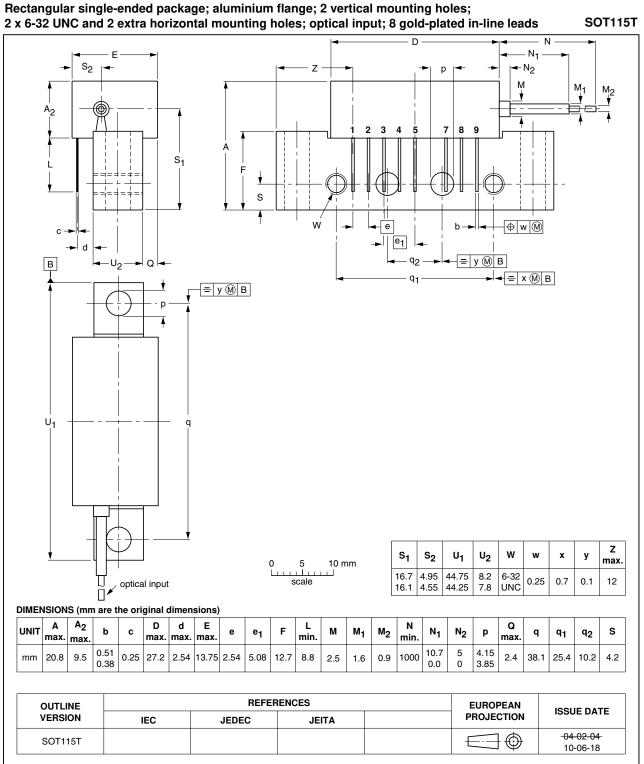


### **NXP Semiconductors**

## BG0827; BG0827/FC0/SC0

870 MHz optical receivers

#### **Package outline** 6.



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BGO827 FC0 SC0

Package outline SOT115T Fig 2.

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**SOT115X** 

#### Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

Е D N<sub>1</sub> s<sub>2</sub> Ζ р  $N_2$ М M<sub>1</sub>  $M_2$ ¥ A<sub>2</sub> 2 7 8 9 3 4 S<sub>1</sub> Т s 4 с 🗕 w 0 w 🕅 е h 🗕 d e<sub>1</sub> Q Uo В - = y M B q2 = y 🕅 B ◄ = x (M) B q1 p Ν R U q 25 mm Scale connector 10 mm z 5 0 s<sub>1</sub> s<sub>2</sub> U<sub>1</sub> s w U2 w х у тŤт max .... Т scale 16.7 4.95 44.75 8.2 6-32 4.2 Ũ 0.25 0.7 0.1 12 16.1 4.55 44.25 7.8 UNC DIMENSIONS (mm are the original dimensions) D Е R Α Α2 d L Q M<sub>2</sub> UNIT F M<sub>1</sub> b с Μ Ν е e<sub>1</sub> N<sub>1</sub>  $N_2$ р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 8.8 2.5 0.9 2.4 38.1 25.4 10.2 35 mm 12.7 1.6 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC JEDEC PROJECTION JEITA 04-02-04  $\bigcirc$ SOT115X ----10-06-18

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**Product data sheet** 

BGO827\_FC0\_SC0

Fig 3. Package outline SOT115X

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SOT115Y

#### Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

Е D N<sub>1</sub> s<sub>2</sub> Ζ р  $N_2$ М M<sub>1</sub> M<sub>2</sub> ¥ A<sub>2</sub> 2 7 8 9 3 4 S<sub>1</sub> Т s 4 с 🗕 w 0 w е h → d e<sub>1</sub>  $U_2$ Q В - = y M B q2 = y 🕅 B q1 p Ν R U q 0 25 mm Scale connector z 10 mm 5 0 s s<sub>1</sub>  $S_2$ U1 U2 w w x у max τŤ. L Π scale 6-32 UNC 16.7 4.95 44.75 8.2 4.2 0.25 0.7 0.1 12 Ũ 7.8 4.55 44.25 16.1 DIMENSIONS (mm are the original dimensions) D Е R Α Α2 d L Q M<sub>2</sub> UNIT F М<sub>1</sub> N<sub>1</sub> b с М Ν  $N_2$ е e<sub>1</sub> р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 8.8 2.5 0.9 2.4 38.1 25.4 10.2 35 mm 12.7 1.6 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC JEDEC PROJECTION JEITA 04-02-05  $\odot$ SOT115Y **—** 10-06-18

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Product data sheet

BGO827 FC0 SC0

Fig 4. Package outline SOT115Y

## 7. Handling information

Fiberglass optical coupling: maximum tensile strength = 5 N; minimum bending radius = 35 mm.

## 8. Revision history

Table 6. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BGO827_FC0_SC0 v.5	20100929	Product data sheet	-	BGO827_FC0_SC0 v.4
Modifications:		of this data sheet has been re f NXP Semiconductors.	edesigned to comply	with the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the ne	w company name wh	nere appropriate.
	<ul> <li>Package ou</li> </ul>	tline and simplified outline dr	awings have been up	odated to the latest version.
BGO827_FC0_SC0 v.4 (9397 750 14436)	20050329	Product data sheet	-	BGO827_FC0_SC0 v.3
BGO827_FC0_SC0 v.3 (9397 750 13061)	20040407	Product specification	-	BGO827_FC0_SC0 v.2
BGO827_FC0_SC0 v.2 (9397 750 10522)	20021210	Product specification	-	BGO827_FC0_SC0 v.1
BGO827_FC0_SC0 v.1 (9397 750 09934)	20020627	Product specification	-	-

## 9. Legal information

### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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#### 870 MHz optical receivers

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